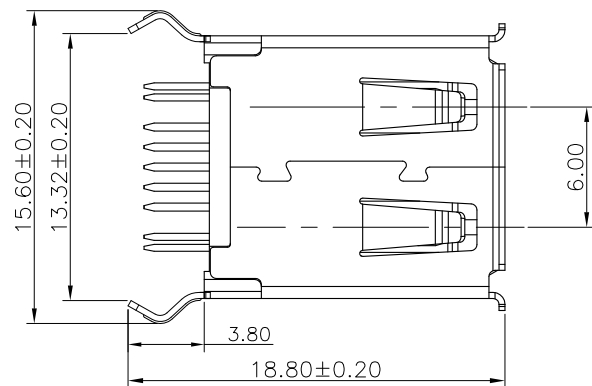
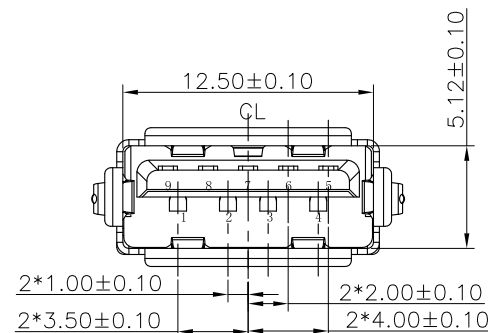
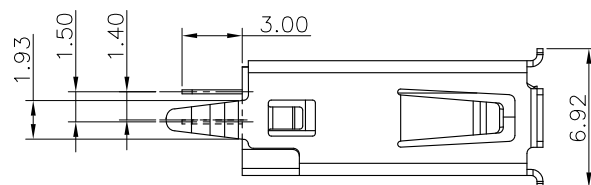
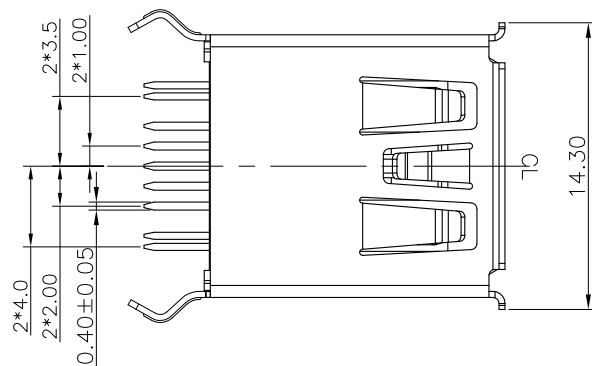


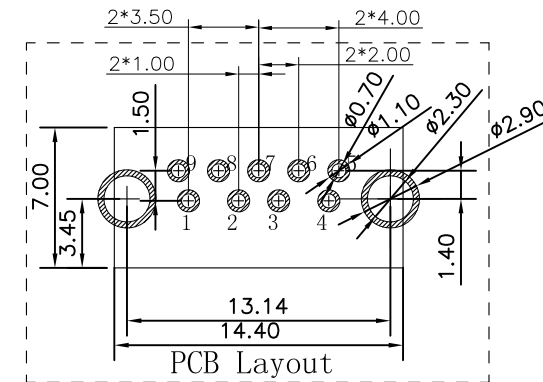
GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
AO			Initial	2014/05/07	Jamie Zie



MATRIX PART NO:

MUSB - 09 - 01 - 62
MATRIX USB Pin Number Series number
Planting
01:Gold Flash
15:15u"
30:30u"



NOTES:

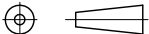
1.MATERIAL:

- 1.1 HOUSING: LCP , Blue
- 1.2 CONTACT: COPPER ALLOY.
- 1.3 SHELL: SUS

2.FINISH:

- 2.1 CONTACT: GOLD PLATING ON CONTACT AREA,MATTE TIN PLATING ON SOLDER TAIL AREA,NICKEL UNDER PLATING.
- 2.2 SHELL: SOLDERABILITY NICKEL PLATING OVER ALL. 50u" MIN.NICKEL UNDERPLATING OVER ALL.

PIN NO.	PIN 1	PIN 2	PIN 3	PIN 4	
SLGNAL NAME	V BUS	D-	D+	GND	
REMARK	USB 2.0 CONTACT PINS				
PIN NO.	PIN 5	PIN 6	PIN 7	PIN 8	PIN 9
SLGNAL NAME	STDA_SSRX-	STDA_SSRX+	GND_DRAIN	STDA_SSTX-	STDA_SSTX+
REMARK	USB 3.0 CONTACT PINS				
 Matrix Electronics Co.,Ltd					

TOLERANCE: X.X X.XX ±0.38 X.XXX ±0.25 X.XXX ±0.13 ANGLE: ±3°		DESIGN BY : Jamie Zie 2014/05/07	PART NAME: USB 3.0, A TYPE, 180° DIP CONNECTOR.	
UNIT: mm [inch]		CHECKED BY: Vicky Hsieh 2014/05/07	PART NO.	MUSB09-01-62
		APPROVED BY1: Richard Hsieh 2014/05/07	MOLD NO.	NA
SCALE:1:1		APPROVED BY2: Richard Hsieh 2014/05/07	DRAW NO.	
SIZE:A4			SHEET NO.	1 OF 1